

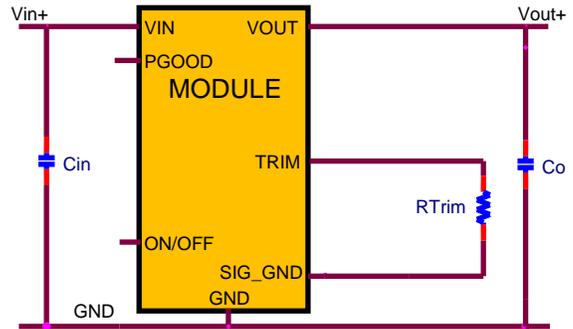
IND065BLV Hornet: Non-Isolated DC-DC Voltage Regulator Modules

12Vdc input; 16Vdc to 34Vdc output; 65W Max Power



Applications

- ✓ Industrial Equipment
- ✓ Control Boards
- ✓ Test Equipment



- 12V (±20%) Input voltage
- Output voltage programmable from 16Vdc to 34Vdc via external resistor
- Remote On/Off for optional external control
- Fixed switching frequency
- Output overcurrent protection (non-latching)

- Small size: 27.9 mm x 11.4 mm x 8.5 mm (1.1 in x 0.45 in x 0.335 in)
- Operating range: -40°C to 85°C ambient

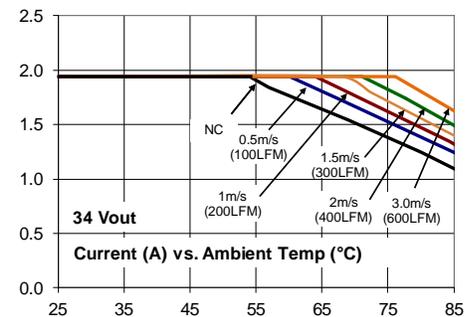
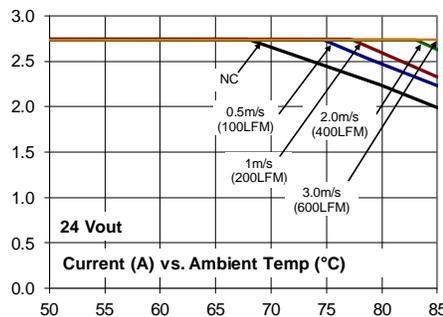
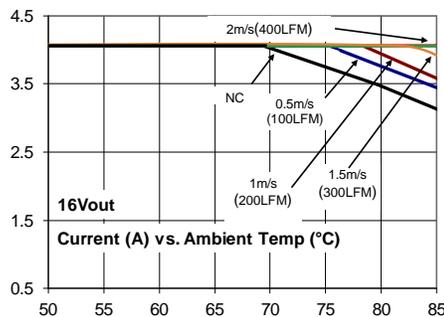
Process and Safety

- Qualified for 1000h High Temperature Operating Bias, 1000h 85RH/85°C Temperature, Humidity and Bias, 700 cycle -40 to 125°C thermal cycling.
- ANSI/UL# 60950-1 2nd Revised October 14, 2014, CSA+ C22.2 No. 60950-1-07, Second Ed. + A2:2014 (MOD) Recognized, DIN EN 60950-1:2006 + A11:2009 + A1:2010 + A12:2011, + A2:2013 (VDE+ 0805-1) Licensed.
- ISO** 9001 and ISO 14001 certified manufacturing facilities.
- Compliant to RoHS II EU "Directive 2011/65/EU".
- Compatible in a Pb-free or SnPb reflow environment.
- Suitable for aqueous clean.
- Suitable for conformal coating with dip and vapor deposition. Conformal coating can provide the protection to meet Salt Fog Test per IEC 60068-2-52 (Severity 3) and Mixed Gas Flow test per Telcordia GR-3108 Outdoor Levels.
- 3 year warranty

Device Code	Input Voltage	Output Voltage	Output Current (Max.)	On/Off Logic	Comcode
IND065BLV	9.6 – 14.4Vdc	16 – 34Vdc	4.06(@16V)	Negative	1600102911A

Thermal Performance

Full rated output with natural convection up to 69°C at 16Vout and up to 54°C at 34Vout.. Thermal curves for 3 voltages below.



Heat Transfer via Conduction

The module can also be used in a sealed environment with cooling via conduction from the module's top surface through a gap pad material to a coldwall, as shown below. The output current derating versus coldwall temperature, when using a thermal pad and a gap filler is shown below.

Thermal pad: Bergquist P/N: GP2500S20

Gap filler: Bergquist P/N: GF2000

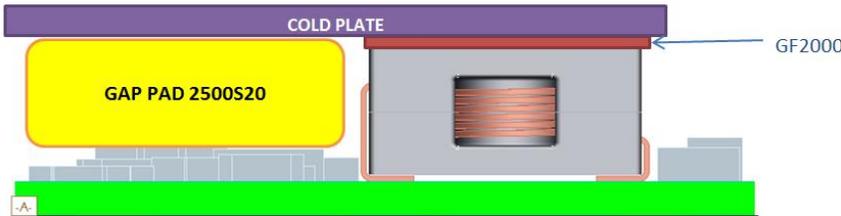
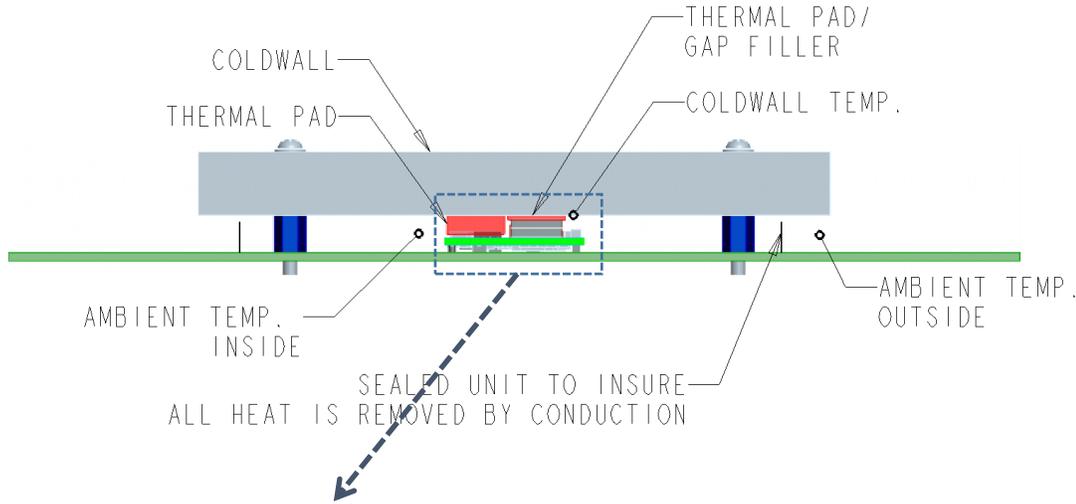


Figure 1. Output Current versus Coldwall Temperature; $V_{IN} = 12V$

Electrical Specifications

Parameter	Device	Symbol	Min	Typ	Max	Unit
Operating Input Voltage	All	V _{IN}	9.6	12	14.4	Vdc
Input No Load Current (V _{IN} = 12.0Vdc, I _o = 0, module enabled)	V _{O,set} = 16 Vdc	I _{IN,No load}			32	mA
	V _{O,set} = 34Vdc	I _{IN,No load}			110	mA
External Capacitance, Ceramic ESR ≥ 1 mΩ	All	C _{O,max}	10	—	100*	μF
Output Current	All	I _o	4.06(16V), 2.71(24V), 2.32(28V), 1.91(34V)			A
Efficiency 12V _{INDC} , T _A =25°C, I=12A, V _o =32 to 34Vdc		η	96(16V), 94.5(24V), 94(28V)			%
Switching Frequency	All	f _{sw}	—	322	—	kHz
Output Voltage (Over all line, load, and temperature conditions)	All	V _{O, set}		3		% V _{O, set}
On/Off Logic High (MODULE OFF) Input High Voltage	All	V _{IH}	2.5	—	16	Vdc
On/ Off Logic Low (MODULE ON) Input Low Voltage	All	V _{IL}	-0.2	—	0.6	Vdc
PGOOD (Power Good)						
Signal Interface Open Drain, V _{supply} ≤ 5VDC						
Overvoltage threshold for PGOOD ON	All			107.6		%V _{O, set}
Overvoltage threshold for PGOOD OFF	All			112.8		%V _{O, set}
Undervoltage threshold for PGOOD ON	All			92.2		%V _{O, set}
Undervoltage threshold for PGOOD OFF	All			87.9		%V _{O, set}
Pulldown resistance of PGOOD pin	All			94		Ω
Sink current capability into PGOOD pin	All		6			mA

*Additional External Capacitance possible using Tunable Loop

Characteristic Curves

The following figures provide typical characteristics for the IND065BLV Hornet at 25°C.

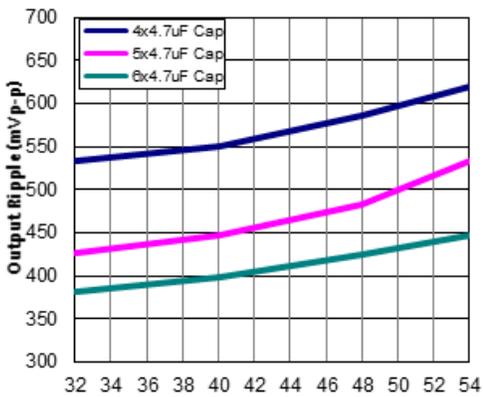


Figure 1. Output Ripple Voltage for various output voltages and external caps @12Vin. Additional Decoupling cap of 0.01uF used on input and output side

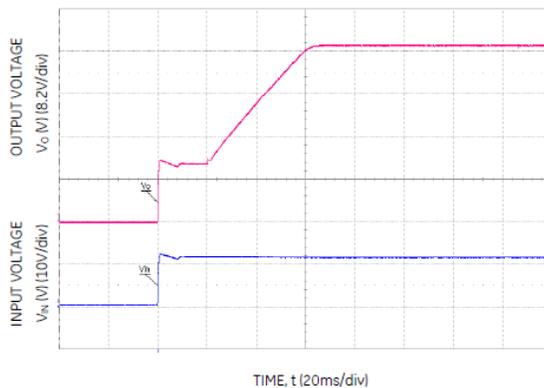


Figure 2. Typical Start-up using Input Voltage (Vin=12V, Vout = Vout, max, Iout = Iout, max)

Use Current (A) = 65 / Output Voltage (V) to determine baseline output current for a specific voltage. Then thermal curves. Interpolate data for intermediate output voltages

Trim

Rtrim for a desired output voltage, should be as per the following table. The formula in the last column helps determine Rtrim for other voltages.

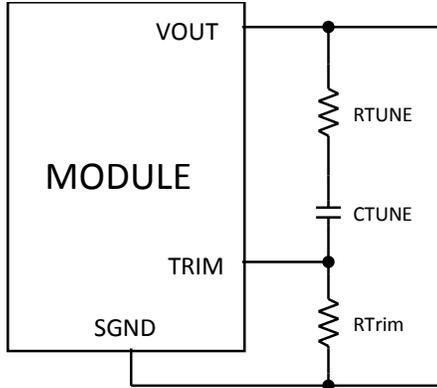
V _o (V)	16	18	20	22	24	28	34	$R_{trim} = \left[\frac{1.2}{(V_o - 1.2)} \right] \times 200.5k\Omega$
Rtrim (kΩ)	16.257	14.321	12.798	11.567	10.553	8.978	7.335	

Safety Considerations

For safety agency approval, the power module must be installed in compliance with the spacing and separation requirements of the end-use safety agency standards listed on the first page of this document. For the converter output to be considered meeting the requirements of safety extra-low voltage (SELV), the input must meet SELV requirements. The power module has extra-low voltage (ELV) outputs when all inputs are ELV. The input to these units is to be provided with a 12A in the positive input lead.

Tunable Loop

The module is designed for 200uF capacitor on its output. For applications where more than 100uF capacitors would be used on the output, an additional Resistor (Rtune) and Capacitor (Ctune) would be required in the circuit schematic to compensate for the additional capacitance. The placement is between the Sense+ pin and Trim pin as per figure below:



The recommended values for Rtune and Ctune for different amounts of external capacitance are as per the table below:

Co	10x10µF	15x10uF	20x10µF	25x10µF	30x10µF
R _{TUNE}	27kΩ	24kΩ	20kΩ	15kΩ	15kΩ
C _{TUNE}	680pF	1500pF	2700pF	3300pF	6800pF

Figure 3. Circuit diagram showing connection of R_{TUNE} and C_{TUNE} to tune the control loop of the module

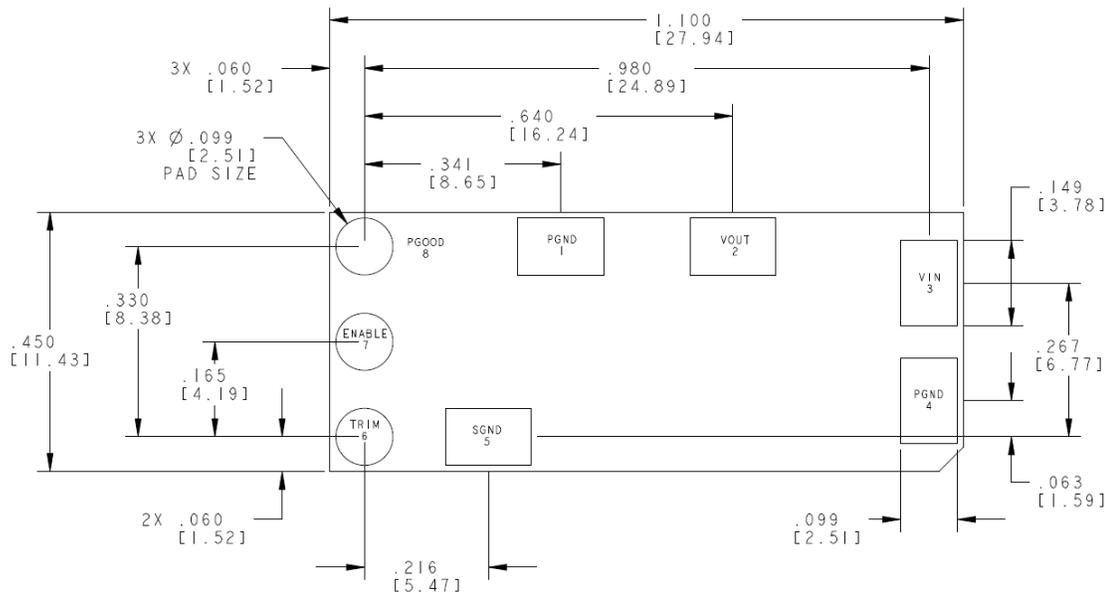
PowerGood (PGOOD)

This is an open-drain output to indicate that the output voltage is within the regulation limits of the module. The PGOOD signal will be de-asserted to a low state if any condition such as overtemperature, overcurrent or loss of regulation occurs that would result in the output voltage going ±10% outside the setpoint value. If not used, leave unconnected.

Recommended Pad Layout

Dimensions are in millimeters and (inches).

Tolerances: x.x mm ± 0.5 mm (x.xx in. ± 0.02 in.) [unless otherwise indicated] x.xx mm ± 0.25 mm (x.xxx in ± 0.010 in.)



Nozzle Recommendations

Stencil thickness of 6 mils minimum must be used for this product. The module weight has been kept to a minimum by using open frame construction. Variables such as nozzle size, tip style, vacuum pressure and placement speed should be considered to optimize this process. The minimum recommended inside nozzle diameter for reliable operation is 3mm. The maximum nozzle outer diameter, which will safely fit within the allowable component spacing, is 7 mm.

Bottom Side / First Side Assembly

This module is not recommended for assembly on the bottom side of a customer board. If such an assembly is attempted, components may fall off the module during the second reflow process.

Lead Free Soldering

The modules are lead-free (Pb-free) and RoHS compliant and fully compatible in a Pb-free soldering process. Failure to observe the instructions below may result in the failure of or cause damage to the modules and can adversely affect long-term reliability.

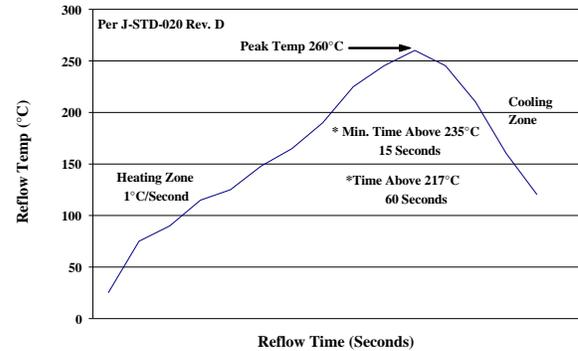
MSL Rating

The modules have a MSL rating of 2a.

Pb-free Reflow Profile

Power Systems will comply with J-STD-020 Rev. D (Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices) for both Pb-free solder profiles and MSL classification procedures. The suggested Pb-free solder paste is Sn/Ag/Cu (SAC).

The following profile is the recommended linear reflow profile using Sn/Ag/Cu solder. Soldering outside of the recommended profile requires testing to verify results and performance.



Storage and Handling

J-STD-033 Rev. A (Handling, Packing, Shipping and Use of Moisture/Reflow Sensitive Surface Mount Devices) is recommended. Moisture barrier bags (MBB) with desiccant are required for MSL ratings of 2 or greater. These sealed packages should not be broken until time of use. Once the original package is broken, the floor life of the product at conditions of $\leq 30^{\circ}\text{C}$ and 60% relative humidity varies according to the MSL rating (see J-STD-033A). The shelf life for dry packed SMT packages will be a minimum of 12 months from the bag seal date, when stored at the following conditions: $< 40^{\circ}\text{C}$, $< 90\%$ relative humidity.

Post Solder Cleaning and Drying Considerations

Post solder cleaning is usually the final circuit-board assembly process prior to electrical board testing. The result of inadequate cleaning and drying can affect both the reliability of a power module and the testability of the finished circuit-board assembly.

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